

APPLICABLE STANDARD						
RATING	OPERATING TEMPERATURE RANGE	-40 °C TO 85 °C	STORAGE TEMPERATURE RANGE	-10 °C TO 50 °C (PACKED CONDITION)		
	VOLTAGE	50 V AC / DC	OPERATING OR STORAGE HUMIDITY RANGE	RELATIVE HUMIDITY 90 % MAX (NOT DEWED)		
	CURRENT	0.5 A (note)	APPLICABLE CABLE	CONDUCTOR END: t=0.3±0.05mm, GOLD PLATING GROUND PLATE: t=0.5±0.05mm, TIN PLATING		
SPECIFICATIONS						
ITEM		TEST METHOD		REQUIREMENTS	QT	AT
CONSTRUCTION						
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.		ACCORDING TO DRAWING.	×	×
MARKING		CONFIRMED VISUALLY.			×	×
ELECTRIC CHARACTERISTICS						
VOLTAGE PROOF		150 V AC FOR 1 min.		NO FLASHOVER OR BREAKDOWN.	×	×
INSULATION RESISTANCE		100 V DC.		500 MΩ MIN.	×	×
CONTACT RESISTANCE		AC 20 mV MAX (1 KHz) , 1 mA .		100 mΩ MAX. INCLUDING FFC BULK RESISTANCE (L=8mm)	×	×
MECHANICAL CHARACTERISTICS						
VIBRATION		FREQUENCY 10 TO 55 Hz, HALF AMPLITUDE 0.75 mm, — m/s ² FOR 10 CYCLES IN 3 DIRECTIONS.		① NO ELECTRICAL DISCONTINUITY OF 1 μs. ② CONTACT RESISTANCE: 100 mΩ MAX.	×	—
SHOCK		981 m/s ² , DURATION OF PULSE 6 ms AT 3 TIMES IN 3 DIRECTIONS.		③ NO DAMAGE, CRACK AND LOOSENESS OF PARTS.		
MECHANICAL OPERATION		20 TIMES INSERTIONS AND EXTRACTIONS.		① CONTACT RESISTANCE: 100 mΩ MAX. ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	×	—
FFC RETENSION FORCE		MEASURED BY APPLICABLE FPC. (THICKNESS OF FFC SHALL BE t=0.30mm AT CONDUCTOR END, t=0.50mm AT GROUND PLATE AT INITIAL CONDITION.)		DIRECTION OF INSERTION: 0.3N × n MIN.	×	—
ENVIRONMENTAL CHARACTERISTICS						
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -40→+15To+35→+85→+15To+35°C TIME 30→ 2~3 → 30→ 2~3 min UNDER 5 CYCLES.		① CONTACT RESISTANCE: 100 mΩ MAX. ② INSULATION RESISTANCE: 50 MΩ MIN. ③ NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	×	—
DAMP HEAT (STEADY STATE)		EXPOSED AT 40±2°C, RELATIVE HUMIDITY 90 TO 95 %, 96 h.			×	—
DAMP HEAT,CYCLIC		EXPOSED AT -10 TO +65 °C, RELATIVE HUMIDITY 90 TO 96 %, 10 CYCLES,TOTAL 240 h.		① CONTACT RESISTANCE: 100 mΩ MAX. ② INSULATION RESISTANCE: 1 MΩ MIN. (AT HIGH HUMIDITY) ③ INSULATION RESISTANCE: 50 MΩ MIN. (AT DRY) ④ NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	×	—
DRY HEAT		EXPOSED AT 85±2 °C, 96 h.		① CONTACT RESISTANCE: 100 mΩ MAX.	×	—
COLD		EXPOSED AT -40±3°C, 96 h.		② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	×	—
	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE	
REMARK				APPROVED	MO. ISHIDA	10. 06. 08
				CHECKED	YN. TAKASHITA	10. 06. 08
				DESIGNED	SJ. OKAMURA	10. 06. 08
				DRAWN	SJ. OKAMURA	10. 06. 08
Unless otherwise specified, refer to JIS C 5402.						
Note QT:Qualification Test AT:Assurance Test X:Applicable Test			DRAWING NO.		ELC4-332362-00	
	SPECIFICATION SHEET		PART NO.	FH48-**S-0. 5SV		
	HIROSE ELECTRIC CO., LTD.		CODE NO.	CL580		1/2

SPECIFICATIONS					
ITEM	TEST METHOD		REQUIREMENTS	QT	AT
CORROSION SALT MIST	EXPOSED AT 35±2℃ , 5 % SALT WATER SPRAY FOR 96 h.		① CONTACT RESISTANCE: 100 mΩ MAX. ② NO EVIDENCE OF CORROSION WHICH AFFECTS TO OPERATION OF CONNECTOR. ③ NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	×	—
SURPHUR DIOXIDE [JIS C 0090]	EXPOSED AT 40±2 ℃ , RELATIVE HUMIDITY 80±5% ,25±5 PPM FOR 96 h.			×	—
HYDROGEN SULPHIDE [JIS C 0092]	EXPOSED AT 40±2 ℃ , RELATIVE HUMIDITY 80±5% ,10 ~ 15 PPM FOR 96 h.			×	—
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, ±5 ℃ FOR IMMERSION DURATION, 2±0.5 sec.	245	A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	×	—
RESISTANCE TO SOLDERING HEAT	1) REFLOW SOLDERING PEAK TMP. 250 ℃ MAX . REFLOW TMP. 230 ℃ MIN FOR 60 sec. 2) SOLDERING IRONS : TMP. 350±10℃ FOR 5±1 sec .		NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	×	—
(note) WHEN THE SAME VALUE OF CURRENT ARE APPLID TO ALL CONTACTS AT THE SAME TIME IN ONCE, SET THE CURRENT TO THE 70 % OF THE RATED CURRENT VALUE.					
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